

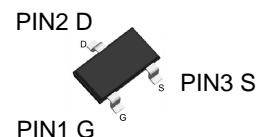
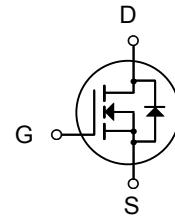


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## MT2300 N-Channel Enhancement Mode MOSFET

### Description

The MT2300 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.



### General Features

$V_{DS} = 20V$   $I_D = 3.0A$

$R_{DS(ON)} < 45m\Omega$  @  $V_{GS}=4.5V$

### Application

SOT23

Battery protection

Load switch

Uninterruptible power supply

### Marking : 2300

### Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 8$	V
Drain Current-Continuous	$I_D$	3.0	A
Drain Current-Pulsed (Note 1)	$I_{DM}$	12	A
Maximum Power Dissipation	$P_D$	0.9	W
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 150	°C
Thermal Resistance,Junction-to-Ambient (Note 2)	$R_{\theta JA}$	139	°C/W



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Parameter	Symbol	Condition	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	20	22	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=20V, V_{GS}=0V$	-	-	1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS}=\pm 12V, V_{DS}=0V$	-	-	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5	0.75	1.2	V
Drain-Source On-State Resistance	$R_{DS(\text{ON})}$	$V_{GS}=2.5V, I_D=2.8A$	-	55	75	$m\Omega$
		$V_{GS}=4.5V, I_D=3A$	-	45	60	$m\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS}=5V, I_D=3A$	-	8	-	S
Input Capacitance	$C_{iss}$	$V_{DS}=10V, V_{GS}=0V, F=1.0\text{MHz}$	-	260	-	PF
Output Capacitance	$C_{oss}$		-	48	-	PF
Reverse Transfer Capacitance	$C_{rss}$		-	27	-	PF
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=10V, R_L=3.3\Omega$ $V_{GS}=4.5V, R_{GEN}=6\Omega$	-	2.5	-	nS
Turn-on Rise Time	$t_r$		-	3.2	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	21	-	nS
Turn-Off Fall Time	$t_f$		-	3	-	nS
Total Gate Charge	$Q_g$	$V_{DS}=10V, I_D=3A,$ $V_{GS}=4.5V$	-	2.9	5	nC
Gate-Source Charge	$Q_{gs}$		-	0.4	-	nC
Gate-Drain Charge	$Q_{gd}$		-	0.6	-	nC
Diode Forward Voltage <sup>(Note 3)</sup>	$V_{SD}$	$V_{GS}=0V, I_S=3.3A$	-	0.75	1.2	V
Diode Forward Current <sup>(Note 2)</sup>	$I_S$		-	-	3.3	A

## Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production



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### Typical Electrical and Thermal Characteristics

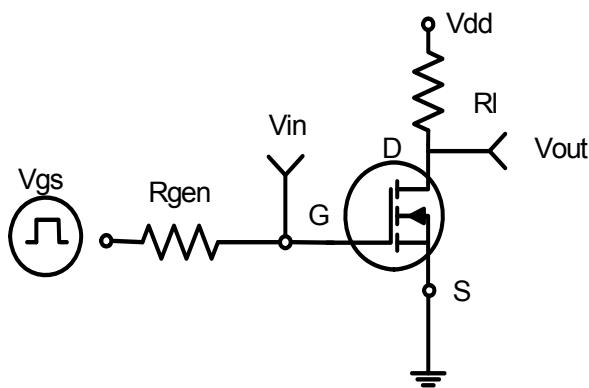


Figure 1:Switching Test Circuit

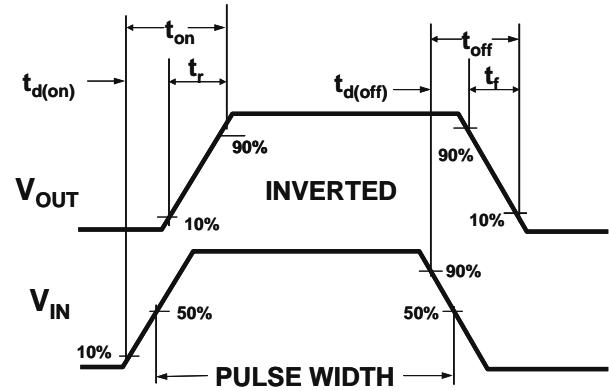


Figure 2:Switching Waveforms

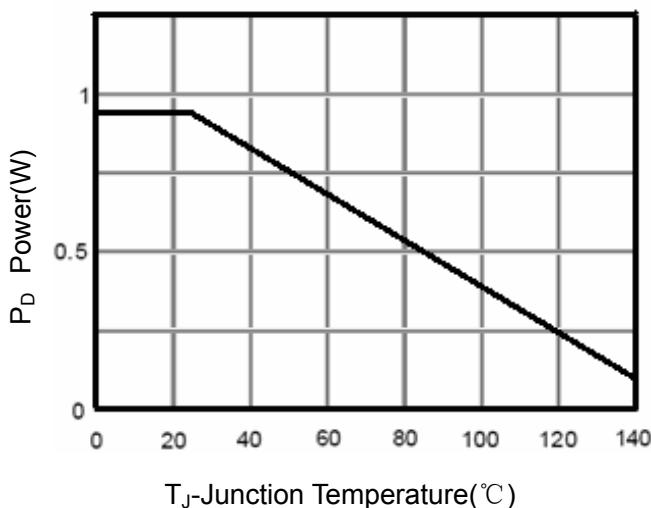


Figure 3 Power Dissipation

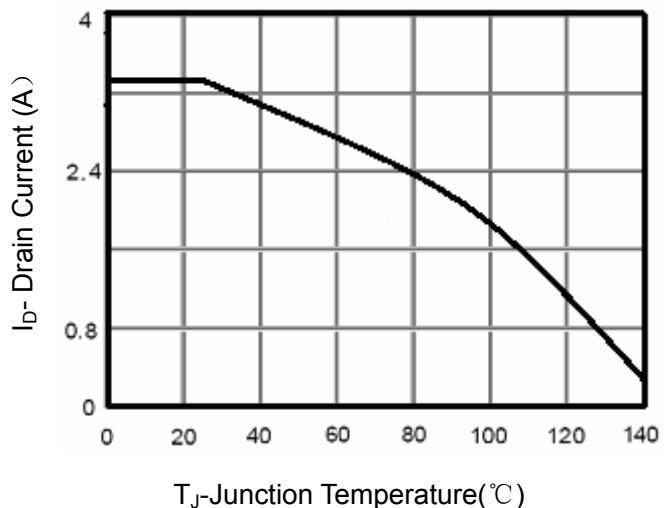


Figure 4 Drain Current

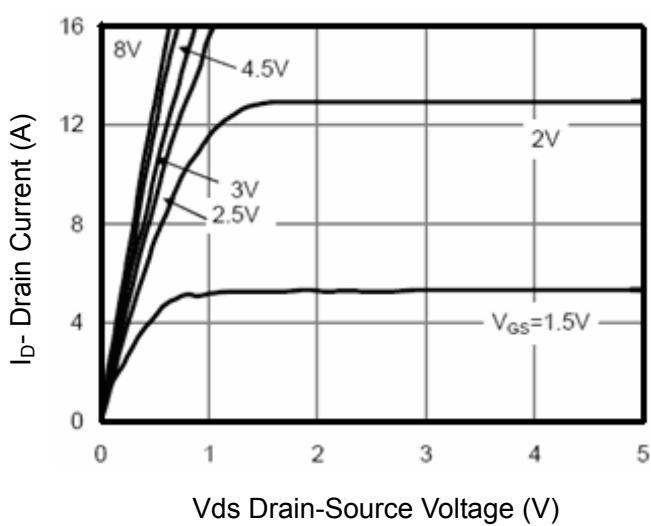


Figure 5 Output Characteristics

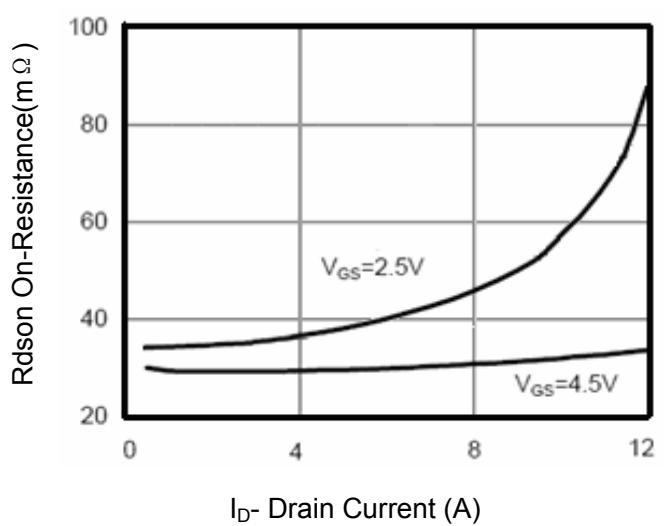
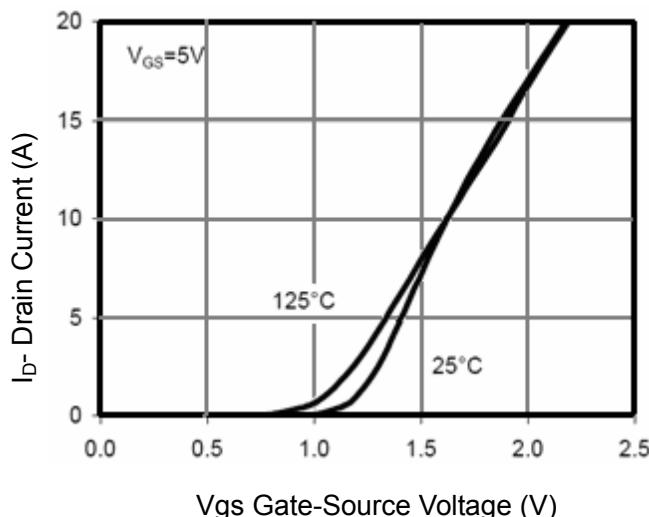


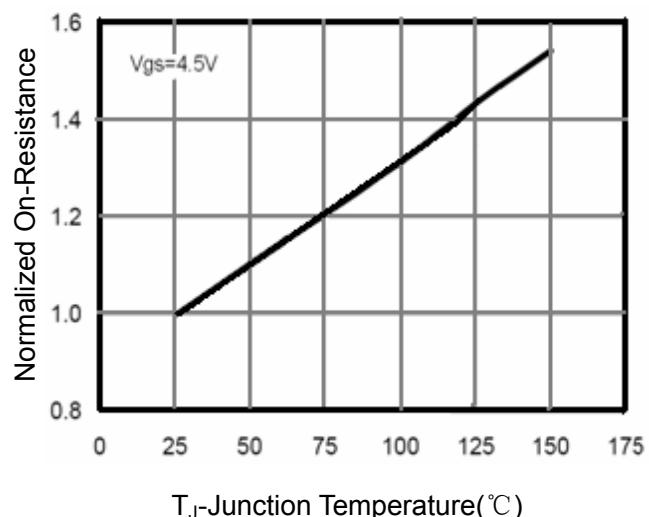
Figure 6 Drain-Source On-Resistance



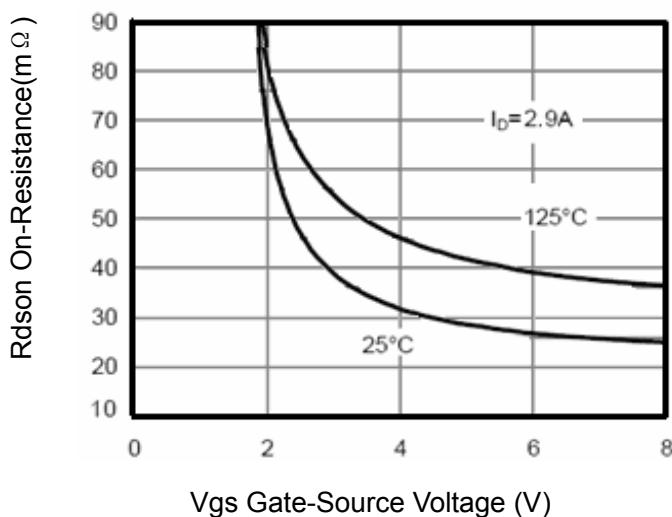
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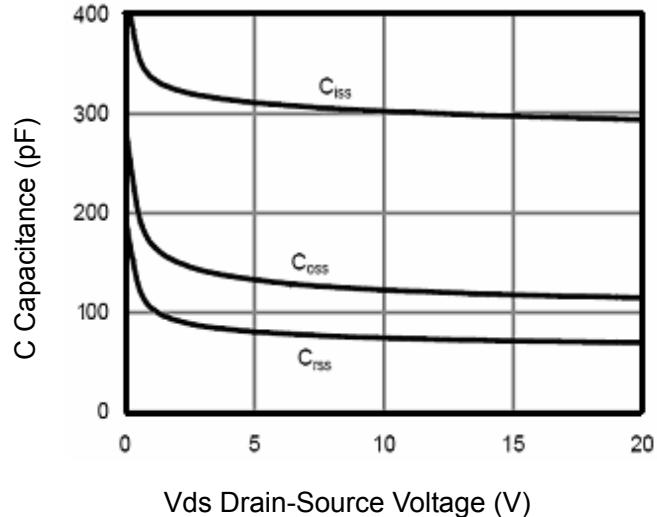
**Figure 7 Transfer Characteristics**



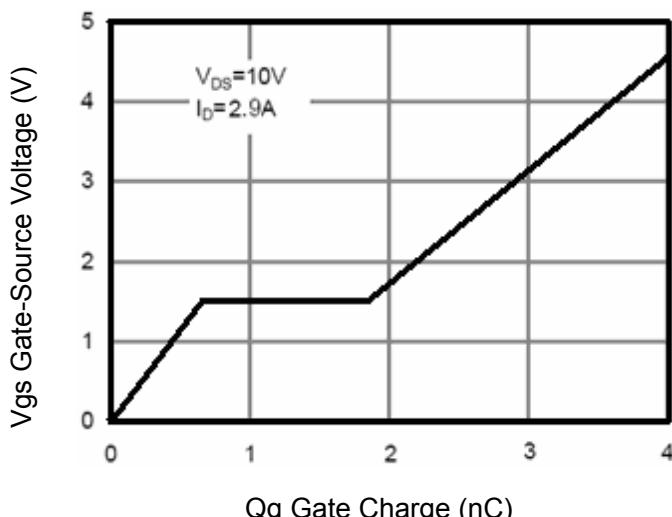
**Figure 8 Drain-Source On-Resistance**



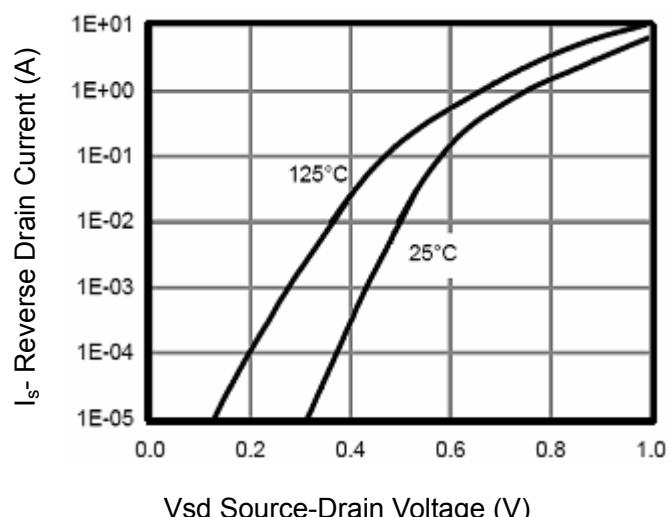
**Figure 9  $R_{DSON}$  vs  $V_{GS}$**



**Figure 10 Capacitance vs  $V_{DS}$**



**Figure 11 Gate Charge**



**Figure 12 Source- Drain Diode Forward**

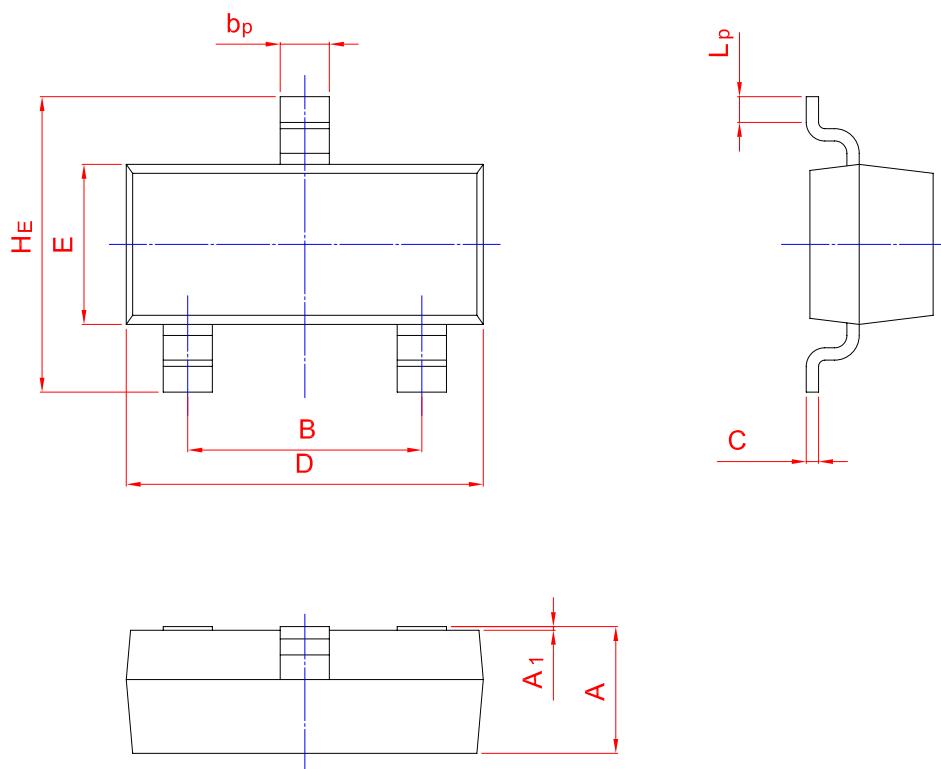


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## PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT-23



UNIT	A	B	$b_p$	C	D	E	$H_E$	$A_1$	$L_p$
mm	1.40 0.95	2.04 1.78	0.50 0.35	0.19 0.08	3.10 2.70	1.65 1.20	3.00 2.20	0.100 0.013	0.50 0.20